



STA335ML

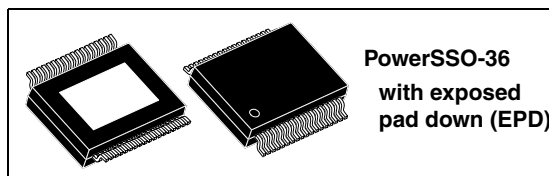
2-channel microless high-efficiency digital audio system Sound Terminal™

Features

- Wide supply voltage range (5.0 V to 26 V)
- PowerSSO-36 exposed pad down package
- 2 channels of 24-bit DDX®
- 100-dB SNR and dynamic range
- Selectable 32 kHz to 48 kHz input sample rates
- Automatic zero-detect mute
- Automatic invalid input detect mute
- 2-channel I²S input data interface
- Selectable clock input ratio (256 or 364 * fs)
- Max power correction for lower full power
- 96-kHz internal processing sample rate, 24-bit precision
- Thermal overload and short-circuit protection embedded
- Filterless configuration capable

Applications

- LCD
- DVD
- Cradle
- Digital speaker
- Wireless speaker cradle



Description

STA335ML is a single die embedding digital audio processing and high-efficiency power amplification, capable of operating without the aid of an external microcontroller.

The STA335ML is part of the Sound Terminal™ family that provides full digital audio streaming to the speakers and offers cost effectiveness, low power dissipation and sound enrichment.

The STA335ML combines a unique 24-bit DDX® digital class-D ternary modulator together with an extremely low R_{dsON} stereo power DMOS stage. The latter is capable of a total output power of 2 x 20 W with outstanding performance in terms of efficiency (>90 %), THD, SNR and EMI.

The microless feature allows its use in low-cost applications (cradle, digital speakers, audio terminals) where no microcontroller is needed.

The serial audio data interface accepts the universally used I²S format. Basic features, such as oversampling clock, gain, I²S format can be set using a minimal number of selection pins.

STA335ML is self-protected against thermal overload, overcurrent, short-circuit and overvoltage conditions.

The fault condition is also signalled on an external pin (INT_LINE) for specific requirements.

Table 1. Device summary

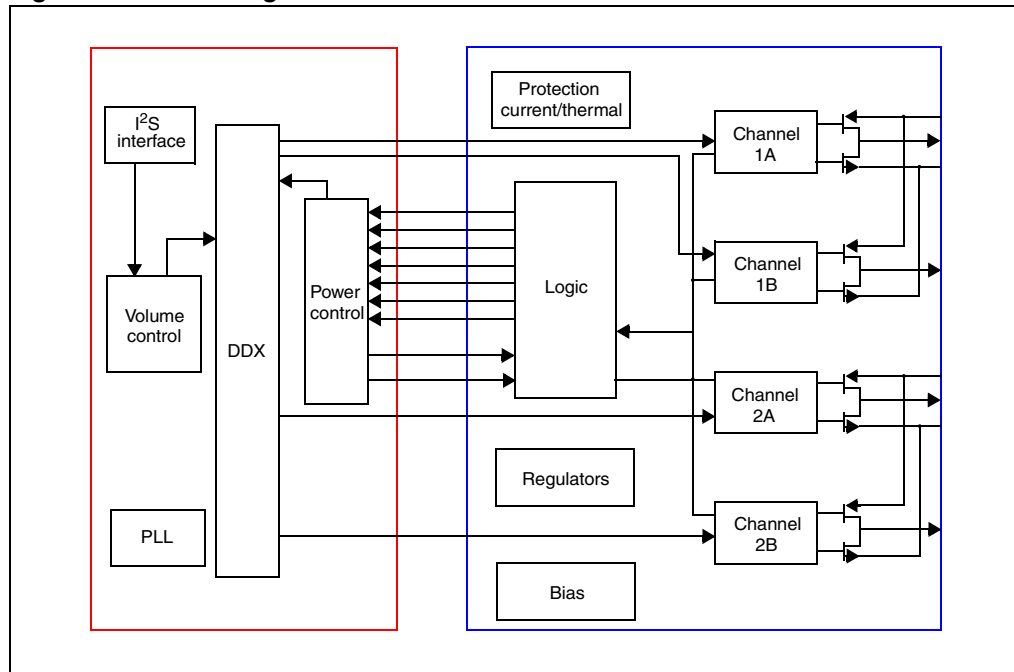
Order code	Package	Packaging
STA335ML	PowerSSO-36 EPD	Tube
STA335ML13TR	PowerSSO-36 EPD	Tape and reel

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1 Block diagram

Figure 1. Block diagram



2 Pin description

Figure 2. Pin connection (top view)

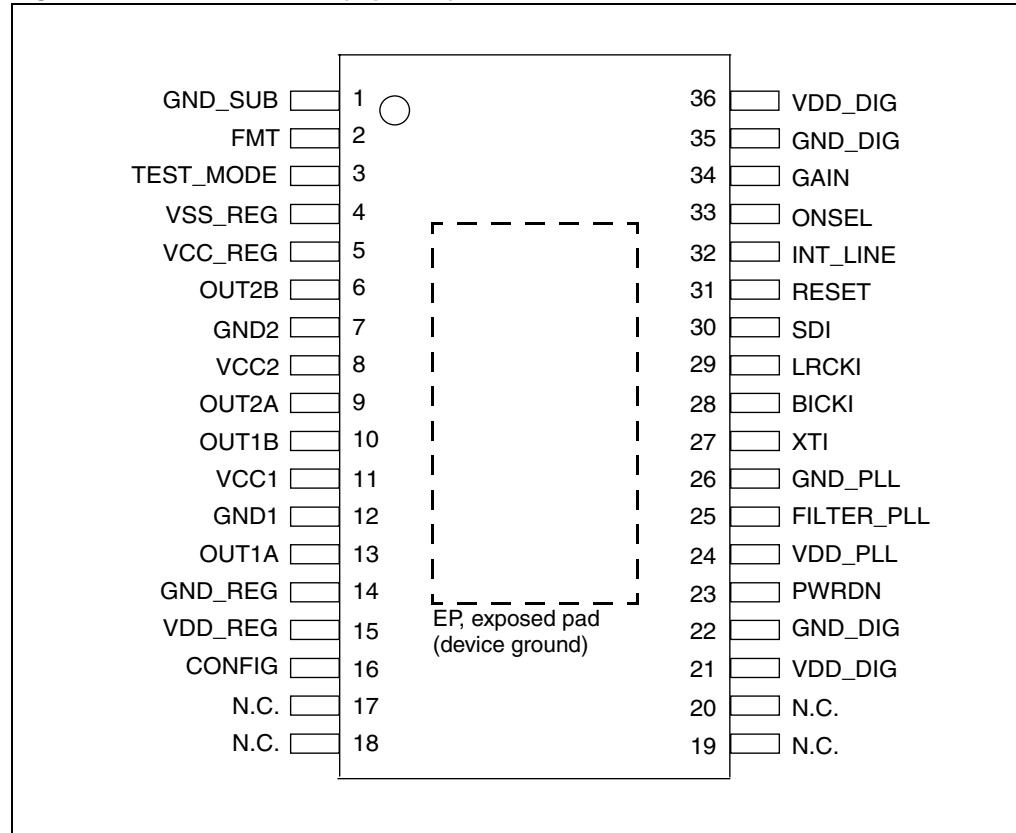


Table 2. Pin description

Pin	Name	Type	Description
1	GND_SUB	Gnd	Substrate ground
2	FMT	In	Serial format: 0: I ² S format 1: left justified
3	TEST_MODE	In	This pin must be connected to GROUND
4	VSS_REG	Analog	Internal reference at V _{CC} - 3.3 V
5	VCC_REG	Analog	Internal V _{CC} reference
6	OUT2B	Out	Output half bridge 2B
7	GND2	Gnd	Power negative supply
8	VCC2	Power	Power positive supply
9	OUT2A	Out	Output half bridge 2A
10	OUT1B	Out	Output half bridge 1B

Table 2. Pin description (continued)

Pin	Name	Type	Description
11	VCC1	Power	Power positive supply
12	GND1	Gnd	Power negative supply
13	OUT1A	Out	Output half bridge 1A
14	GND_REG	Analog	Internal ground reference
15	VDD_REG	Analog	Internal 3.3-V reference voltage
16	CONFIG	In	Configuration mode, must be connected to ground
17	N.C.	-	No internal connection
18	N.C.	-	No internal connection
19	N.C.	-	No internal connection
20	N.C.	-	No internal connection
21	VDD_DIG	Power	Positive supply digital
22	GND_DIG	Gnd	Digital ground
23	PWRDN	In	Power down: 0: low power mode 1: normal operation
24	VDD_PLL	Power	Positive supply for PLL
25	FILTER_PLL	In	Connection to PLL filter
26	GND_PLL	Gnd	Negative supply for PLL
27	XTI	In	PLL input clock, 256 * fs or 384 * fs
28	BICKI	In	I ² S serial clock
29	LRCKI	In	I ² S left/right clock
30	SDI	In	I ² S serial data channel
31	RESET	In	Reset
32	INT_LINE	Out	Fault interrupt
33	ONSEL	In	Oversampling selector: 0: 256 * fs 1: 384 * fs
34	GAIN	In	Gain selector: 0: 0 dBFs 1: 24 dBFs
35	GND_DIG	Gnd	Digital ground
36	VDD_DIG	Power	Digital supply
-	EP	-	Exposed pad for PCB heatsink, to be connected to ground plane

3 Electrical specifications

3.1 Absolute maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Power supply voltage (pins VCC1, VCC2)	-	-	30	V
V _L	Logic input interface	-0.3	-	4	V
V _{DD}	Digital supply (pin VDD_DIG)	-	-	4	V
T _{op}	Operating junction temperature	-20	-	150	°C
T _{stg}	Storage temperature	-40	-	150	°C

3.2 Thermal data

Table 4. Thermal data

Symbol	Parameter	Min	Typ	Max	Unit
R _{Th(j-case)}	Thermal resistance junction to case (thermal pad)	-	1.5	2	°C/W
T _{sd}	Thermal shut-down junction temperature	140	-	150	°C
T _{hsd}	Thermal shut-down hysteresis	18	20	22	°C
T _w	Thermal warning temperature	120	130	140	°C

3.3 Recommended operating condition

Table 5. Recommended operating condition

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Power supply voltage (pins VCC1, VCC2)	5	-	26	V
V _L	Logic input interface	2.7	3.3	3.6	V
V _{DD}	Digital supply (pin VDD_DIG)	2.7	3.3	3.6	V
T _{amb}	Ambient temperature	-20	-	70	°C

3.4 Electrical specifications - digital section

Table 6. Electrical specifications for digital section

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{il}	Input current without bias device	$V_i = 0 \text{ V}$	-10	-	10	μA
I_{ih}		$V_i = V_{DD} = 3.6 \text{ V}$	-10	-	10	μA
V_{il}	Low level input voltage	-	-	-	$0.2 * V_{DD}$	V
V_{ih}	High level input voltage	-	$0.8 * V_{DD}$	-	-	V
V_{ol}	Low level output voltage	$I_{ol} = 2 \text{ mA}$	-	-	$0.4 * V_{DD}$	V
V_{oh}	High level output voltage	$I_{oh} = 2 \text{ mA}$	$0.8 * V_{DD}$	-	-	V
I_{pu}	Pull-up/down current	-	25	66	125	μA
R_{pu}	Equivalent pull-up/down resistance	-	-	50	-	$\text{k}\Omega$

3.5 Electrical specifications - power section

The specifications given here are with the operating conditions: $V_{CC} = 18 \text{ V}$, $V_{DD} = 3.3 \text{ V}$, $f_{sw} = 384 \text{ kHz}$, $T_{amb} = 25 \text{ }^\circ\text{C}$, $R_L = 8 \text{ }\Omega$ unless otherwise specified.

Table 7. Electrical specifications for power section

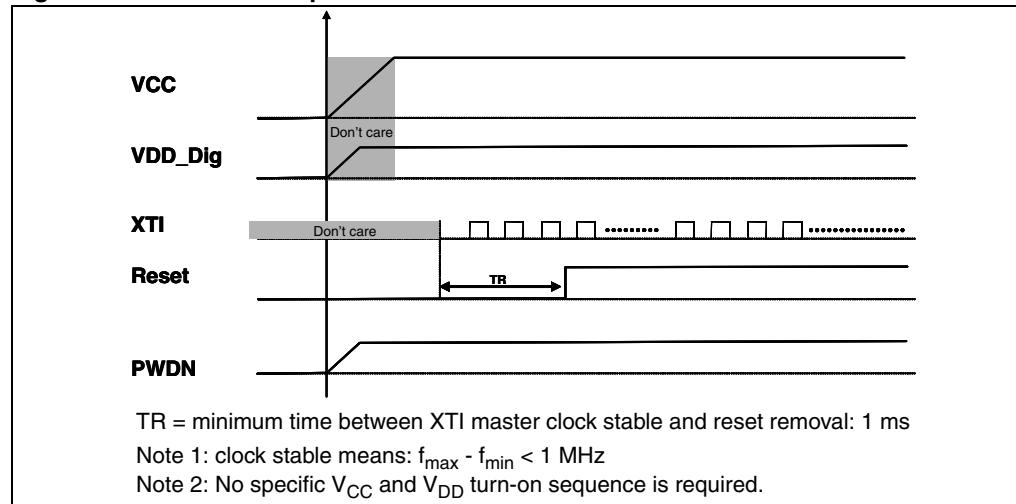
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
P_o	Output power BTL	THD = 1 %	-	16	-	W
		THD = 10 %	-	20	-	
R_{dsON}	On resistance of power P-channel/N-channel MOSFET (Total bridge)	$I_d = 1 \text{ A}$	-	180	250	$\text{m}\Omega$
I_{dss}	Power P-channel/N-channel leakage current	$V_{CC} = 20 \text{ V}$	-	-	10	μA
g_P	Power P-channel R_{dsON} matching	$I_d = 1.5 \text{ A}$	95	-	-	%
g_N	Power N-channel R_{dsON} matching	$I_d = 1.5 \text{ A}$	95	-	-	%
I_{LDT}	Low current dead time (static)	Resistive load Figure 4	-	8	15	ns
I_{HDT}	High current dead time (dynamic)	Load = 1.5 A (Figure 5)	-	15	30	ns
t_r	Rise time	Resistive load Figure 4	-	10	18	ns
t_f	Fall time	Resistive load Figure 4	-	10	18	ns

Table 7. Electrical specifications for power section (continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{VCC}	Supply current from V_{CC} in power down	PWRDN = 0	-	0.1	1.0	mA
	Supply current from V_{CC} in operation	PCM Input signal = -60 dBFS. Switching frequency = 384 kHz No LC filters	-	52	60	mA
I_{VDD_DIG}	Supply current DDX processing (reference only)	Internal clock = 49.152 MHz	-	55	70	mA
I_{SCP}	short circuit protection	Hi-Z output	4.0	4.2	-	A
UVL	Undervoltage protection threshold	-	-	3.5	4.3	V
t_{min}	Output minimum pulse width	No load	20	30	60	ns
DR	Dynamic range	-	-	100	-	dB
SNR	Signal to noise ratio	A-weighted	-	100	-	dB
THD+N	Total harmonic distortion + noise	DDX stereo mode, $P_o = 1\text{ W}$, $f = 1\text{ kHz}$	-	0.2	-	%
PSRR	Power supply rejection ratio	DDX stereo, <5 kHz Vripple = 1 V RMS Audio input = dither only	-	80	-	dB
X_{TALK}	Crosstalk	DDX stereo, <5 kHz One chan. driven at 1 W other channel measured	-	80	-	dB
η	Peak efficiency, DDX mode	$P_o = 2 \times 20\text{ W}$ into $8\ \Omega$	-	90	-	%

3.6 Power-on sequence

Figure 3. Power-on sequence



3.7 Test circuits

Figure 4. Resistive load

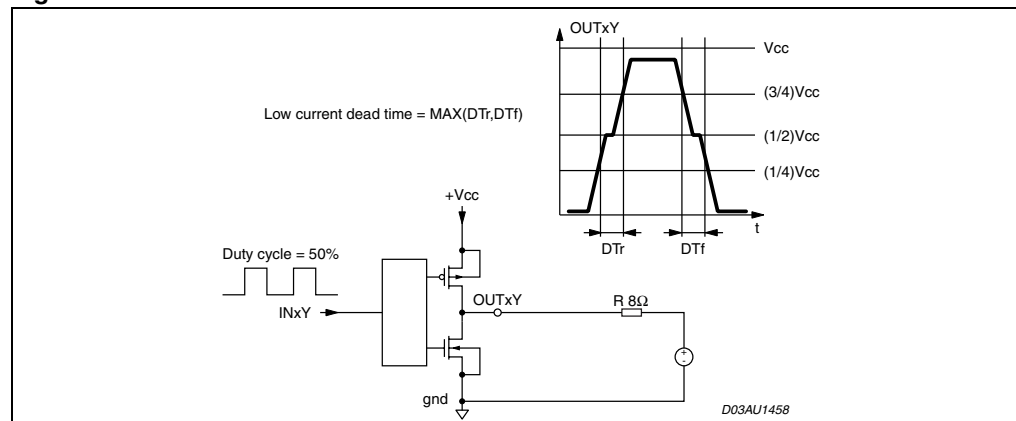
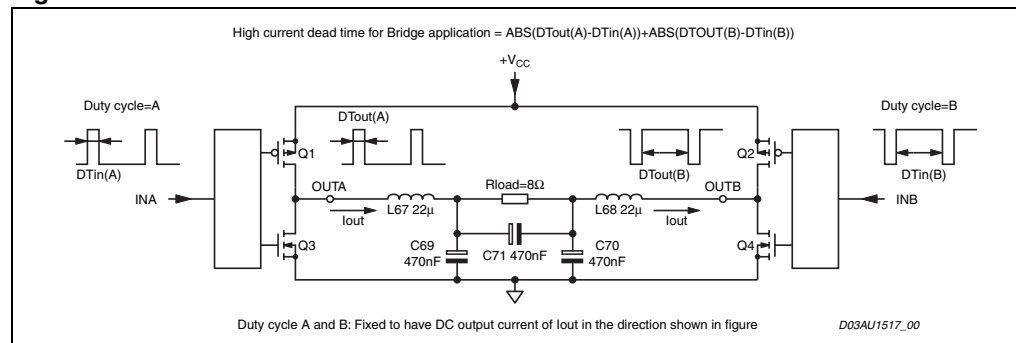


Figure 5. Test circuit



4 Functional description

4.1 Serial audio interface protocols

The STA335ML serial audio input interfaces with standard digital audio components and accepts serial data formats. The STA335ML always acts as a slave when receiving audio input from standard digital audio components. Serial data for two channels is provided using 3 input pins: left/right clock LRCKI (pin 29), serial clock BICKI (pin 28), and serial data SDI (pin 30).

The available formats are given in [Figure 6](#) and [Figure 7](#). Pin FMT (pin 2) selects the format such that FMT = logical 0 gives the I²S format and FMT = logical 1 gives the left justified.

Figure 6. I²S

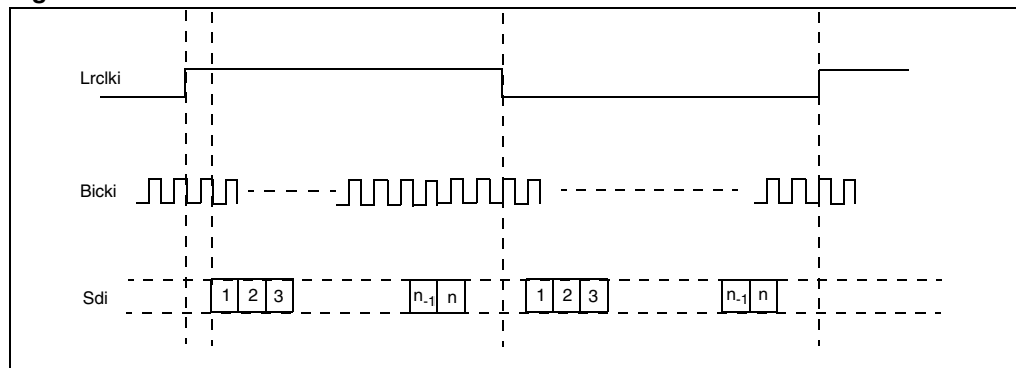
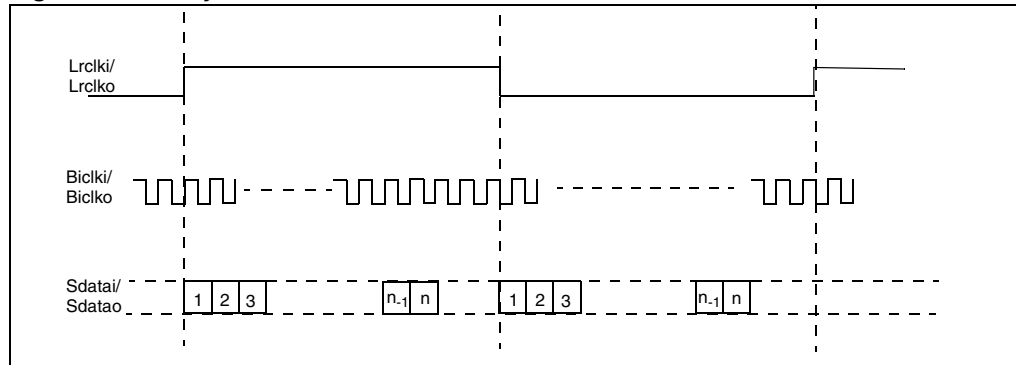


Figure 7. Left justified



4.2 Fault detect recovery bypass

The on-chip STA335ML power output block provides feedback to the digital controller using inputs to the power control block. The fault input is used to indicate a fault condition (either over-current or thermal). When fault is asserted (set to 0), the power control block attempts a recovery from the fault by asserting the 3-state output (setting it to 0 which directs the power output block to begin recovery), holds it at 0 for 1 ms and then toggles it back to 1. This sequence is repeated for as long as the fault exists.

4.3 Zero-detect mute enable

If this function is enabled, the zero-detect circuit examines each processing channel to see if 2048 consecutive zero value samples (regardless of fs) are received. If so the channel is muted.

4.4 Fade-in/out feature

The STA335ML has internal fade-in / fade-out feature when powered on or off, or after a fault condition.

4.5 Oversampling selector

Pin ONSEL (33) is used to configure the PLL to accept $256 \cdot f_s$ or $384 \cdot f_s$ master clock. Where f_s is the I²S LRCKI frequency:

ONSEL = logical 0 gives $256 \cdot f_s$
ONSEL = logical 1 gives $384 \cdot f_s$.

4.6 Gain selector

Pin GAIN (34) is used to configure the STA335ML gain:

GAIN = logical 0 gives 0 dBFs
GAIN = logical 1 gives 24 dBFs.

4.7 Power-down function

Pin PWDN (23) is used to power down the STA335ML:

PWDN = logical 0 sets the power down mode
PWDN = logical 1 gives normal operation.

If the power stage is switched off then the PLL is also switched off.

It is possible to use the PWDN function as a mute function.

5 Applications

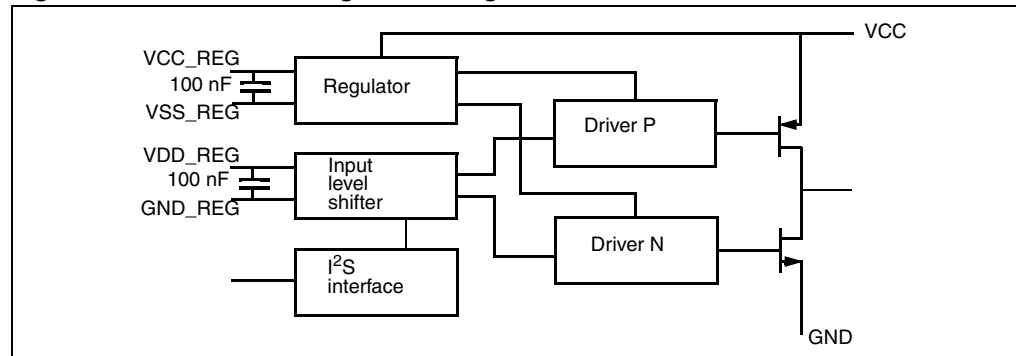
5.1 Applications schematic

Figure 10 on the next page shows the schematic of a typical application for the STA335ML. Concerning the power supplies, take care when designing the PCB layout. In particular, the 3.3- Ω resistors on the digital supplies (VDD_DIG) must be placed as close as possible to the device. This helps to prevent parasitic oscillation in the digital part of the device due to the inductive tracks of the PCB. The same rule applies for all the decoupling capacitors in order to limit any spikes on the supply pins.

5.2 Internal voltage reference

An embedded voltage regulator produces the reference voltages for the DMOS bridge driver. It requires two 100 nF capacitors to keep the regulator stable. The capacitors should be placed close to the pins.

Figure 8. Reference voltage block diagram



5.3 PLL filter schematic

It is recommended to use the circuit in *Figure 9* below for the PLL loop filter to achieve the best performance from the device in general application. Note that the ground of this filter scheme has to be connected to the ground of the PLL without any resistive path. Concerning the component values, please take into account that the greater is the filter bandwidth, the less is the lock time but the higher is the PLL output jitter.

Figure 9. PLL applications schematic

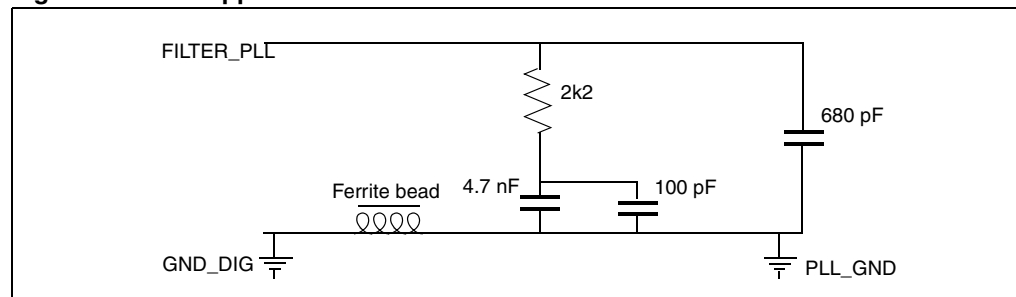
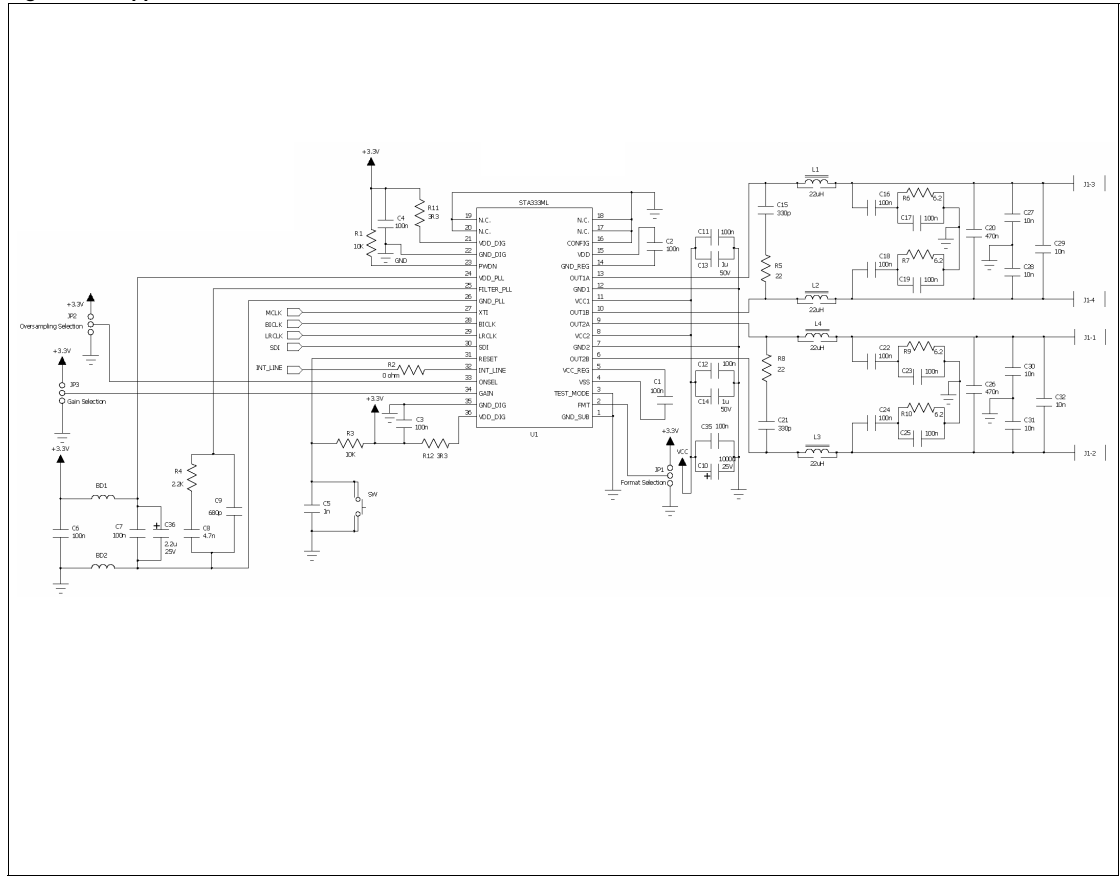


Figure 10. Applications schematic



5.4 Typical output configuration

Figure 11, Figure 12 and Figure 13 show the typical output circuits used for the BTL stereo mode. Please refer to the application note for all the other recommended output configurations.

Figure 11. Output configuration for stereo BTL mode

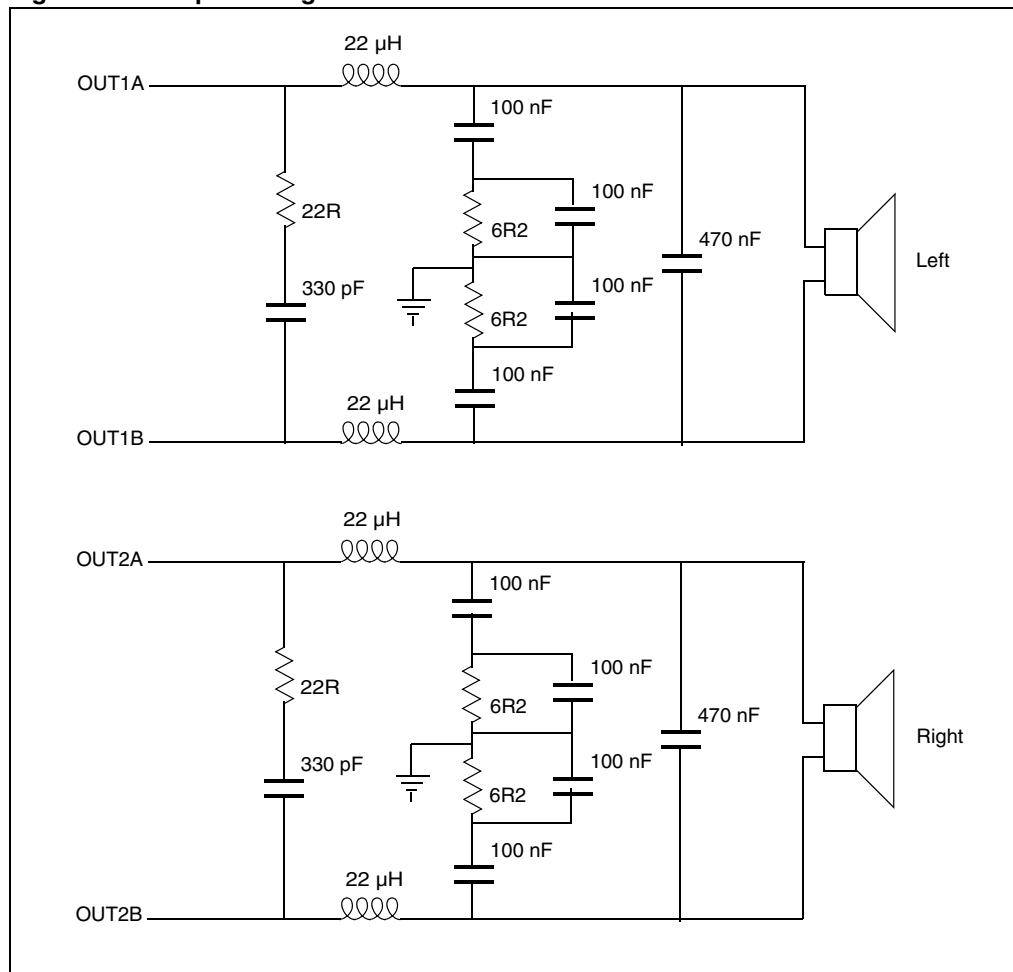
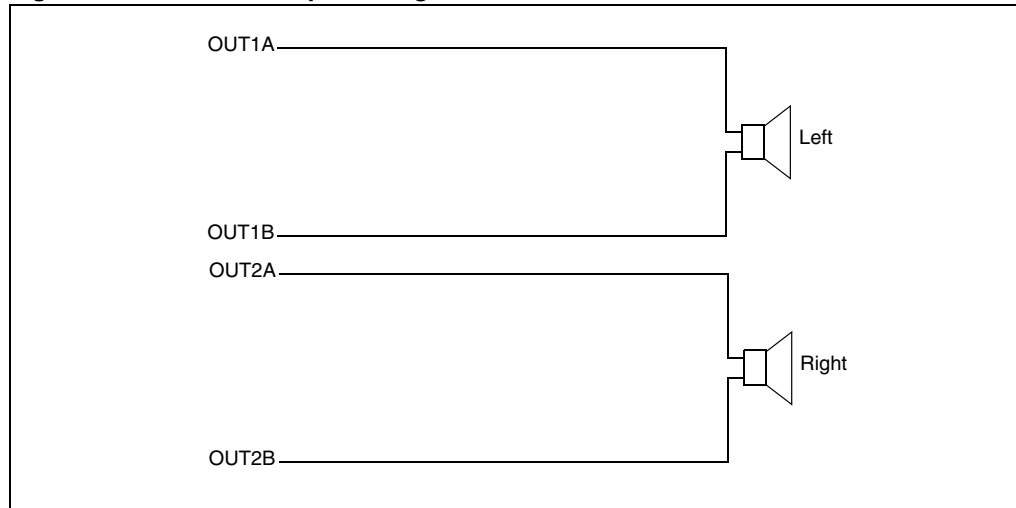
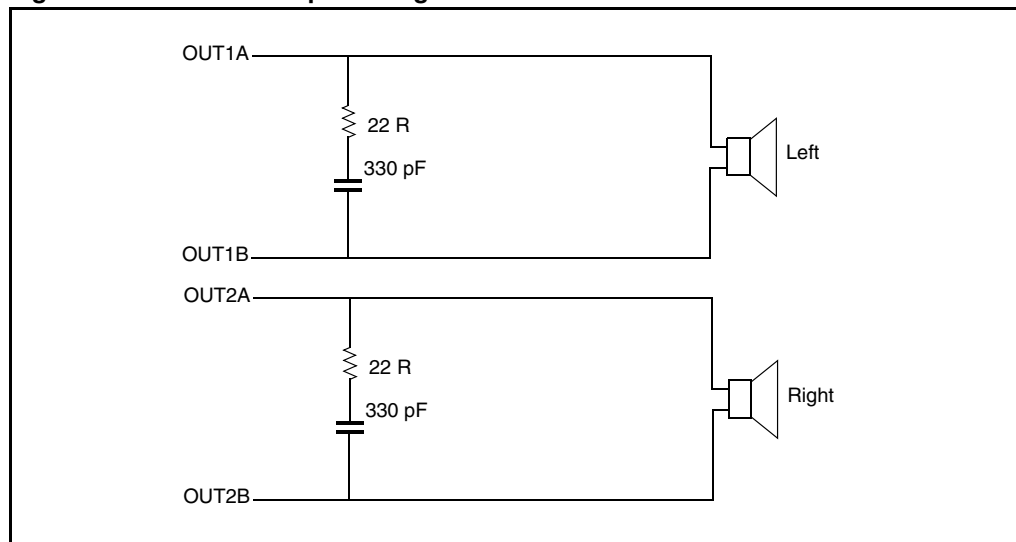


Figure 12. Filterless output configuration

The filterless application is more critical in terms of EMI. It is quite important to follow the suggestions below:

- Tracks from amplifier to speaker should be as short as possible.
- Ferrite beads can be used (instead of coils) to improve EMI performance.
 - Ferrite beads must have a low impedance in the audio band and high impedance at high frequencies.
 - Place ferrite beads as close as possible to the IC.
 - Ferrite filters must reduce EMI above 1 MHz.
 - FCC and CE authorities test radiated emission above 30 MHz.

Figure 13. Filterless output configuration with snubber network

The presence of snubber networks reduce the EMI. The snubber networks should be placed as close as possible to the IC.

6 Package thermal characteristics

Using a double layer PCB the thermal resistance junction to ambient with 2 copper ground areas of $3 \times 3 \text{ cm}^2$ and with 16 via holes (see [Figure 14](#)) is $24 \text{ }^\circ\text{C/W}$ in natural air convection.

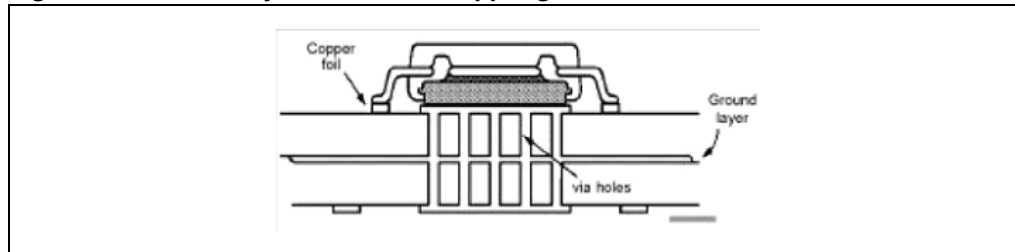
The dissipated power within the device depends primarily on the supply voltage, load impedance and output modulation level.

The max estimated dissipated power for the STA335ML is:

$2 \times 20 \text{ W}$ into $8 \text{ }\Omega$, at 18 V

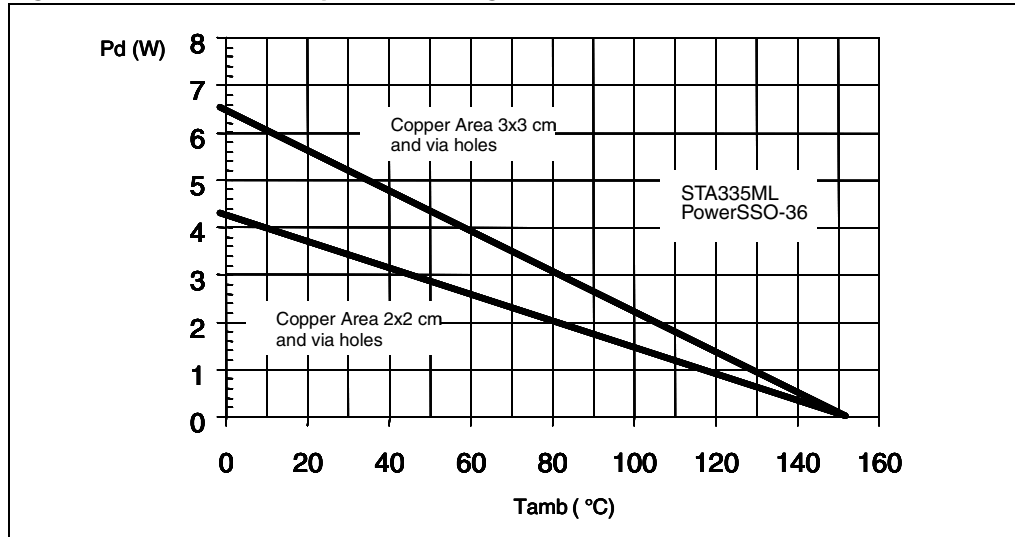
P_d max is approximately 4 W

Figure 14. Double layer PCB with 2 copper ground areas and 16 via holes



[Figure 15](#) shows the power derating curve for the PowerSSO-36 package on a board with two copper areas of $2 \times 2 \text{ cm}^2$ and $3 \times 3 \text{ cm}^2$.

Figure 15. PowerSSO-36 power derating curve



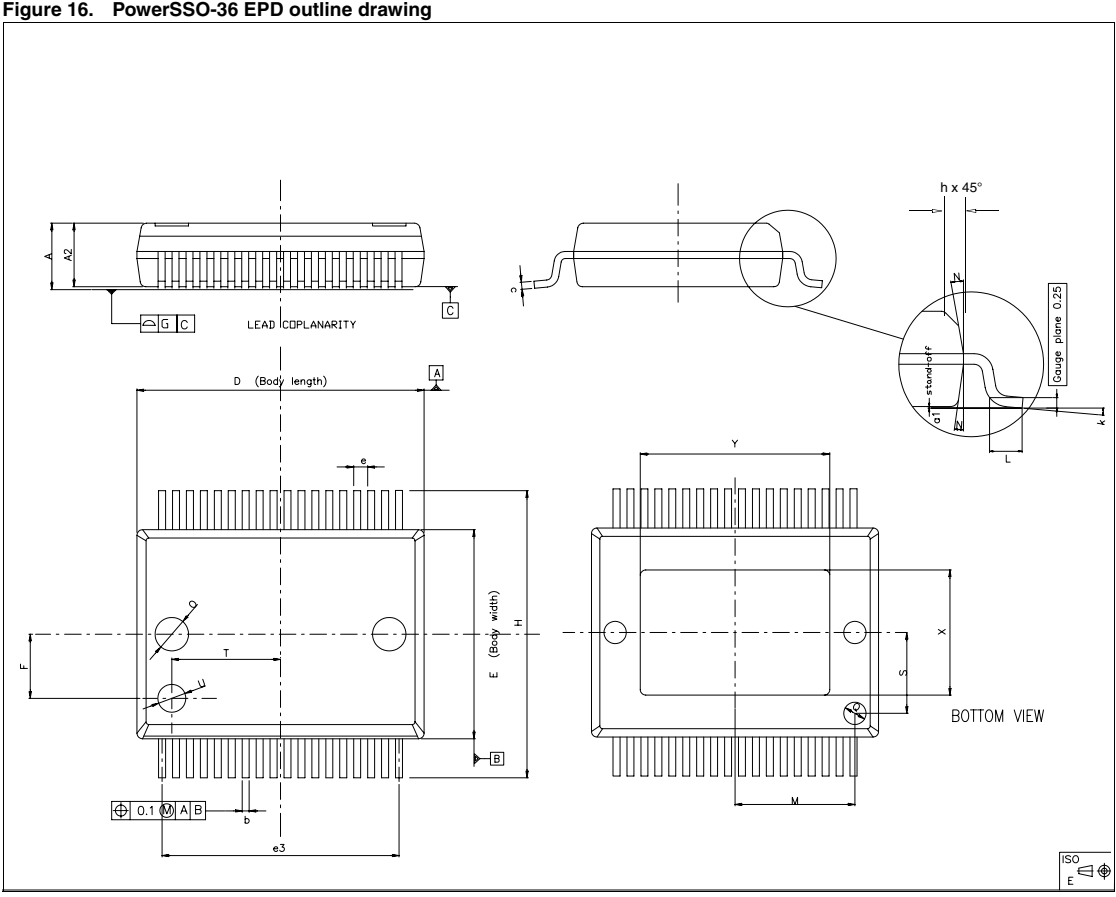
7 Package mechanical data

Figure 16 on page 18 shows the package outline and the table below gives the dimensions.

Table 8. PowerSSO-36 EPD dimensions

Symbol	Dimensions in mm			Dimensions in inches		
	Min	Typ	Max	Min	Typ	Max
A	2.15	-	2.47	0.085	-	0.097
A2	2.15	-	2.40	0.085	-	0.094
a1	0.00	-	0.10	0.00	-	0.004
b	0.18	-	0.36	0.007	-	0.014
c	0.23	-	0.32	0.009	-	0.013
D	10.10	-	10.50	0.398	-	0.413
E	7.40	-	7.60	0.291	-	0.299
e	-	0.5	-	-	0.020	-
e3	-	8.5	-	-	0.335	-
F	-	2.3	-	-	0.091	-
G	-	-	0.10	-	-	0.004
H	10.10	-	10.50	0.398	-	0.413
h	-	-	0.40	-	-	0.016
k	0	-	8 degrees	0	-	8 degrees
L	0.60	-	1.00	0.024	-	0.039
M	-	4.30	-	-	0.169	-
N	-	-	10 degrees	-	-	10 degrees
O	-	1.20	-	-	0.047	-
Q	-	0.80	-	-	0.031	-
S	-	2.90	-	-	0.114	-
T	-	3.65	-	-	0.144	-
U	-	1.00	-	-	0.039	-
X	4.10	-	4.70	0.161	-	0.185
Y	4.90	-	7.10	0.193	-	0.280

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.



8 Revision history

Table 9. Document revision history

Date	Revision	Changes
09-May-2007	1	Initial release.
20-Feb-2008	2.0	Application note added
29-Sep-2008	2.1	Package information updated
18-Dec-2008	2.2	Overcurrent Limit removed
24-Jun-2010	3	Updated junction temperature range in Table 3: Absolute maximum ratings on page 6 Updated Table 7: Electrical specifications for power section on page 7 Removed max estimated dissipated power example on page 16

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